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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Serial No.: Yaqi Cheng, et al.
09/671,326
Filed: September 26, 2000
Customer No.: 23494
Title: Multi-Line ADSL Modem

Docket No.: TI-28221
Art Unit: 2631
Examiner: Khanh C. Tran
Conf. No.: 6078

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<input type="checkbox"/> CONTINUATION APP'N (# Pages)	
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NAME OF INVENTOR(S): Yaqi Cheng, et al.	
TITLE OF INVENTION: Multi-Line ADSL Modem	
TI FILE NO.: TI-28221	DEPOSIT ACCT. NO.: 20-0668
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